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FORM P10-1449	ATTT. DAT NO.	01-279-CON	3EK. 110.	10/18/164	ŀ
	APPLICANT	TESHIMA			
	FILING DATE	February 27, 2004	GROUP	2/26	

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out-	S/N 09/489,475	Jan. 21, 2000	Kimura et al.		
	S/N 09/675,209	Sept. 29, 2000	Suzuki et al.		
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a	JP-A-5-283562 *	10/29/93	JAPAN				х	
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	JP-A-7-45765 *	2/14/95	JAPAN				х	
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	JP-A-3-20067 * ·	1/29/91	JAPAN				Х	
	GB 2146174 .	4/11/85	U.K.				х	
on	JP-A-4-249353.* ·	9/4/92	JAPAN	. /			.X	

^{*} Full English text of the JP Document will be available in machine-translated form from JP (Japanese Patent Office) English language web site at http://www1.ipdl.jpo.go.jp/PA1/cgi-bin/PA1INDEX.

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ATTY. DKT NO. 01-279-CON

APPLICANT TESHIMA

FILING DATE February 27, 2004

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	APPLICANT	TESHIMA	
	FILING DATE	February 27, 2004	GROUP XX6

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Á	JP-A-2000-174180 ·	6/23/00	JAPAN		\times		X (Abstract)	
								

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